	© Co	terial Compo pyright 2005. IPC, Bannoc international and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lowe	r level j	parts, the	declaratio	on encor	npasses a	ll lower le	vel materia	als for v	which th	item is an assembly e manufacturer has eclaration.
1752-2 1.1	rd		Form Type *Declaration Class *DistributeClass 6 - RoHS Yes/No, Homogene						eous Ma	aterials	and Mfg Informat				
Supplier Information															
Company Name *		Company Unique ID		Unique ID Au	Ithority	Resp	onse Date	e *		Response	Docume	nt ID			
SEMTECH CORPORATION 00-847-9941		00-847-9941		DUNS		2013-	2013-08-29								
Contact Name * Roya Reader		Title - Contact QA Customer Service Specialis		Phone - Contact * 805-389-2742		Email - Contact * rreader@semtech.com			1	Duplicate Contact -> Authorized Representative					
Authorized Representati Roya Reader		Title - Representative QA Customer Servic		-	resentative * 2		- Repres er@semt			Supplier C	Comments	s or URL f	or Addit	ional In	formation
Requester Item Number	r	Mfr Item Number		Mfr Item Name)	Effecti	ve Date	Version	Manufa	facturing Site		eight *	UON	1	Unit Type
		EClamp2378K.TCT									5.7	702	mg		Each
Alternate Recommenda	ation							Alternate Item C		omments					
Manufacturing Proces	ss In	formation													
Terminal Plating / Grid Array	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL R	ating	Peak Proc	cess Body	Temper	ature Max	Time at Pe	eak Tempe	rature N	lumber o	of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy			1			с					seco	onds 3	5		
EClamp2378K.TCT is RI	EACH	I-compliant product	, per EU R	egulation EC	C1907/2006 to in	clude r	ecent add	dition of	SVHC	candidate	list of su	ubstance	s in Jun	ne 2013	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a fine a file in a s	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second sec	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem			Homogeneous Material	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Toleran	ce PPM	
Name	Name				weight	Measure			Level	Substance Category			Substance	CAS				-		
-	I -I	Die	+N	л-м	Doped Silicon	0.3458	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.3458	mg		60,646
-	I -I	Leadframe	+N	л-м	С7025 - МНТ	2.49385	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		2.3916	mg		419,42
			-									+S	-s	Si	7440-21-3		0.0181	mg		3,171
								+C	-C	в		+S	-s	Nickel	7440-02-0		0.0798	mg		13,995
								+C	-C	Supplier		+S	-s	Mg	7439-95-4		0.0044	mg		765
			+N	л-м	Ni/Pd/Au plating	0.06394	mg	+C	-C	В		+S	-s	Nickel	7440-02-0		0.0577	mg		10,112
					•			+C	-C	Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0052	mg		920
								+C	-C	Supplier	outer plating	+S	-s	Au	7440-57-5		0.001	mg		183
-	I -I	Molding compound	+N	и-м	EME-G770HCD	2.635223	Smg	+C	-C	Supplier		+S	-s	Silica fused	60676-86-0		2.4639	mg		14,145
			,		•							+S	-s	Epoxy resin	Proprietary		0.0791	mg		13,864
												+S	-s	Phenol resin	Proprietary		0.0791	mg		432,10
												+S	-s	Carbon black	1333-86-4		0.0132	mg		2,311
-	I -I	Die Attach Epoxy	+N	л-м	QMI519	0.08264	mg	+C	-C	Supplier		+S	-s	Ag	7440-22-4		0.0661	mg		11,595
			,		•							+S	-s	palladium compound	Proprietary		0.0001	mg		22
												+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000004	mg		1
												+S	-s	Hydroquinone	123-31-9		0.00000	mg		0
												+S	-s	Acrylate	Proprietary		0.0131	mg		2,297
												+S	-s	Bismaleimide resin	Proprietary		0.0025	mg		435
												+S	-s	Polymer of polybutadie	Proprietary		0.0008	mg		145